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PAGE 1/6 * RCVD AT 10/7/2005 2:09:49 PM [Eastern Daylight Time] * SVR:USPTO-EFXRF-6/1 * DNIS:8729306 * CSID:5109233360 * DURATION (mm:ss):01:56

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Reference to:
Application No.: 10/765,346
Filing date: 1/26/2004
Art unit: 2813
Applicants: Hui Peng
Title: New Flip Chip Assemblies and Lamps of High Power GaN LEDs, Wafer Level Flip Chip Package Process, and Method of Fabricating the Same
Examiner/Art Unit: Jennifer M. Dolan/2313

Fremont, CA, Oct. 7, 2005

AMENDMENT A

Commissioner for Patents
P.O. Box 450
Alexandria, Virginia 22315-1450

Sir/Ms.:

This letter responds to the Office Action Summary. Please amend the above patent application as follows:

TITLE: Amendment to the title of the above patent application is on page 2 of this amendment.

SPECIFICATION: There is no amendment to the specification.

CLAIMS: Amendment to the claims of the above patent application begin on page 5 of this amendment.

DRAWINGS: There is no amendment to the drawings.

REMARKS: Remarks begin on page 5 of this amendment.